

MCOT256064B1A	A-GM 256 x 64		Green	OLED Module	
			Specification		
Versio	on: 6		Date: 03/10/2017		
	1		Revision		
1	30/04/2	014	First Revision.		
2	04/05/2014		Modify ICC.		
3	16/06/2014		Add Low Temperature storage.		
4 22/12/2015		015	Modify life time.		
5	01/06/2016		Modify static electricity test.		
6	29/09/2	017	Modify Reliability test condition.		

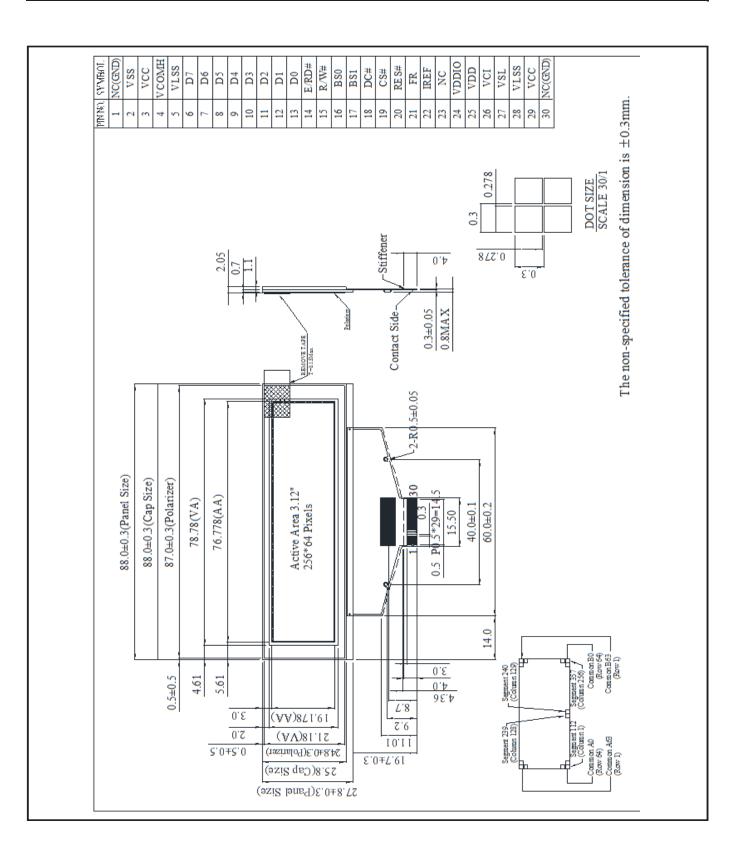
Display				
Resolution	256 x 64			
Appearance	Green on Black			
Logic Voltage	ogic Voltage 5V			
Interface	Parallel / Serial		compliant	
Module Size	88.00 x 27.80 x 2.05			
Operating Temperature	-40°C ~ +70°C	Box Quantity	Weight / Display	
Construction	ТАВ			

\* - For full design functionality, please use this specification in conjunction with the SSD1322 specification.(Provided Separately)

Display Accessories				
Part Number	Description			
MPBV4-Iss2	Interface board compatible with any display that requires a direct solder connection to 0.7, 0.8, 0.845 or 1 mm. Supports any driver board that can be wired to a 2mm pitch 44-way DIL.			

Optional Variants				
Appearance	Voltage			
White on Black				
Blue on Black				
Yellow on Black				

Mechanical Specifications								
Module Size	Module Size88.00 x 27.80 x 2.05 (Without Backlight)W x H x D mm							
Active Area	76.778 x 19.178	W x H mm	Hole-to-Hole		W x H mm			
Dot Size	0.278 x 0.278	W x H mm	Dot Pitch	0.30 x 0.30	W x H mm			



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Pin layout							
Pin	Symbol	Description	Remarks				
1	NC	No Connection. Must connect to external Ground.					
		Ground of Logic Circuit.					
2	VSS	Ground pin, also acts as a reference for logic pins. Must					
		connect to external ground.					
2	NCC	Power Supply for OLED Panel.					
3	VCC	Most positive voltage supply pin of the chip. They must be connected to external source.					
		Voltage Output High Level for COM Signal.					
Λ		Input pin for the voltage output high level for COM signals. A					
4	VCOMH	tantalum capacitor should be connected between this pin and					
		VSS.					
~	V/I CO	Ground of Analogue Circuit.					
5	VLSS	These are the analogue ground pins. They should be connected to VSS externally.					
		Host Data Input / Output Bus.					
		8-bit bi-directional data bus pins to be connected to the					
6 40		microprocessor's data bus. When serial mode is selected, D1					
6~13	D7~D0	will be the serial data input SDIN and D0 will be the serial					
		clock input SCLK. Unused pins must be connected to VSS					
		except for D2 in serial mode					
		Read / Write Enable or Read.					
		MCU interface input. When interfacing to a 6800					
		microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is					
		pulled high and the CS# is pulled low.					
14	E/RD#	When connecting to an 8080 microprocessor, this pin					
		receives the Read (RD#) signal. Data read operation is					
		initiated when this pin is pulled low and CS# is pulled low.					
		When serial mode is selected, this pin must be connected to					
		VSS.					
		Read / Write Select or Write.					
		MCU interface input. When interfacing to a 6800 series					
		microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull					
15	R/W#	it to "Low" for write mode.					
10		When 8080 interface mode is selected, this pin will be the					
		Write (WR#) input. Data write operation is initiated when this					
		pin is pulled low and the CS# is pulled low. When serial					
		mode is selected, this pin must be connected to VSS.					
16	BS0	Communicating Protocol Select.					
		MCU interface selection input. See below table:					
		3-Wire SPI: BS0=1 BS1=0 4-Wire SPI: BS0=0 BS1=0					
17	BS1	6800 Parallel: BS0=1 BS1=1					
		8080 Parallel: BS0=0 BS1=1					
	1	Data / Command Control.					
40		When the pin is pulled high, the input at D7~D0 is treated as					
18	D/C#	display data. When the pin is pulled low, the input at D7~D0					
		will be transferred to the command register.					
		Chip Select.					
19	CS#	Chip Select Input. The chip is enabled for MCU					
		communication only when CS# is pulled low.					
20	RES#	Power Reset for Controller and Driver.					
20	REO#	Reset signal input. When the pin is low, initialization of the chip is executed.					
0.1							
21	FR	Frame Frequency Triggering Signal.					

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		This pin will send out a signal that could be used to identify the driver status. Nothing should be connected to this pin. It should be left open individually.	
22	IREF	<b>Current Reference for Brightness Adjustment.</b> Segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 10uA.	
23	NC	No Connection. Reserved for compatible and flexible design.	
24	VDDIO	Power Supply for I/O Pin Power supply pin of I/O buffer. It should be connected to VDD or external source. All I/O signal should have VIH reference to VDDIO. When I/O signal pins (BS0~BS1, D0~D7, control signals) pull high, they should be connected to VDDIO.	
25	VDD	<b>Power Supply for Core Logic Circuit.</b> Voltage supply pin. It can be supplied externally (within the range of 2.4~2.6V) or regulated internally from VCI. A capacitor should be connected between this pin & VSS under all circumstances.	
26	VCI	Power Supply for Operation. This is a voltage supply pin. It must be connected to external source & always be equal to or higher than VDD & VDDIO.	
27	VSL	Voltage Output Low Level for SEG Signal.This is segment voltage reference pin.When external VSL is not used, this pin should be left open.When external VSL is used, this pin should connect with resistor and diode to ground.	
28	VLSS	Ground of Analogue Circuit. These are the analogue ground pins. They should be connected to VSS externally.	
29	VCC	<b>Power Supply for OLED Panel.</b> Most positive voltage supply pin of the chip. They must be connected to external source.	
30	NC	No Connection. Must connect to external Ground.	

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Absolute Maximum Ratings									
Item Symbol Condition Min Typ Max Unit									
Power Supply (Logic)	VDD	25°C	-0.5		2.75	V			
Power Supply (Display)	VCC	25°C	-0.5		20.00	V			
Supply Operation Voltage	VCI		-0.3		4.00	V			
Supply Voltage for I/O Pins	VDDIO		-0.5		VCI	V			
Operating Temperature	TOP		-40		70	°C			
Storage Temperature	TSTG		-40		80	°C			

	Electronic Characteristics									
Item	Symbol	Condition	Minimum	Typical	Maximum	Unit				
Input High Voltage	VIH		0.8xVDDIO		VDDIO	V				
Input Low Voltage	VIL		0		0.2xVDDIO	V				
Output High Voltage	VOH		0.9xVDDIO		VDDIO	V				
Output Low Voltage	VOL		0		0.1xVDDIO	V				
Power Supply for I/O Pins	VDDIO		1.65	3.00	VCI					
Low Voltage Power Supply	VCI		2.40	3.00	3.50					
Supply Voltage for Logic	VDD		2.40	2.50	2.60	V				
Supply Voltage for Display	VCC		14.00	14.50	15.00	V				
CIEx(Green)		x,y(CIE1931)	0.24	0.28	0.32					
CIEy(Green)		x,y(CIE1931)	0.59	0.63	0.67					
50% Check Board Operating Current.	IDD	VCC=14.5V	23.00	25.00	32.00	mA				

OLED Characteristics								
ltem	Symbol	Condition	Minimum	Typical	Maximum	Unit		
Viewing Angle	θ(V)		160			Deg		
	(H)φ		160			Deg		
Contrast Ratio	CR	Dark	2000:1					
Deenenee Time	T Rise			10		μs		
Response Time	T Fall			10		μs		
Display with 50% check board brightness.			100	120		Nits		

OLED Life Time							
Item Conditions		Typical	Remark				
Operating Life Time	Ta=25°C. Initial checkboard brightness,.	50,000 Hours					

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